

C1632X7R1H224M115AC

TDK Item Description : C1632X7R1H224MT****

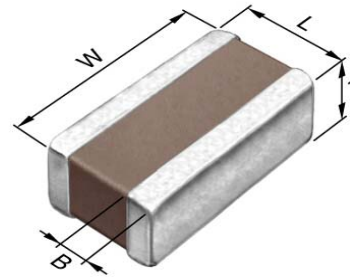


Application & Main Feature

Commercial Grade (Low ESL Reverse Geometry)

Series

C1632 [EIA CC0612]



Dimensions

L 1.60mm +/-0.2mm
 W 3.20mm +/-0.2mm
 T 1.15mm +/-0.15mm
 B 0.20mm Min.

Temperature Characteristic

X7R (-55 to 125 degC +/-15%)

Rated Voltage

1H (50Vdc)

Capacitance

220nF

Capacitance Tolerance

M (+/-20%)

Dissipation Factor

3% Max.

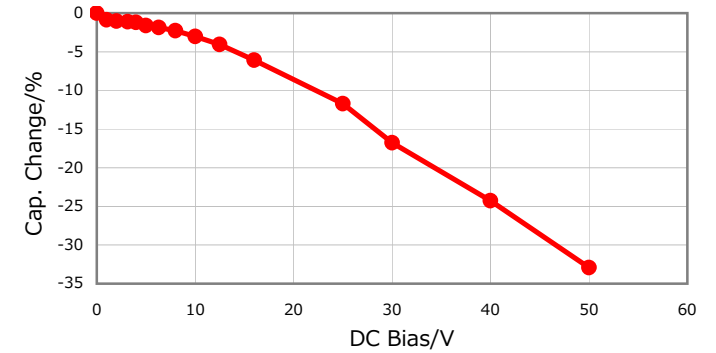
Insulation Resistance

2.27Gohm Min.

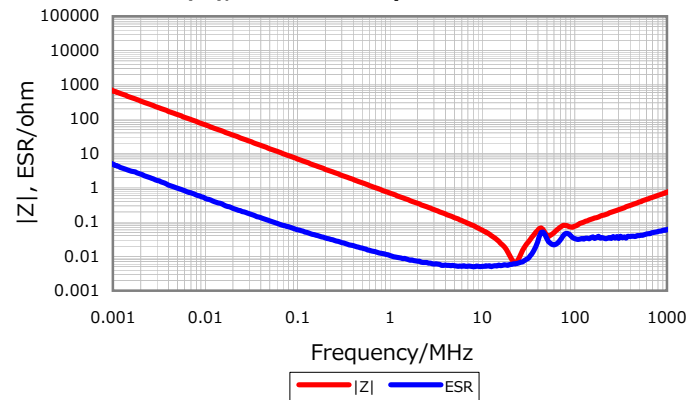
AEC-Q200

Not Applicable

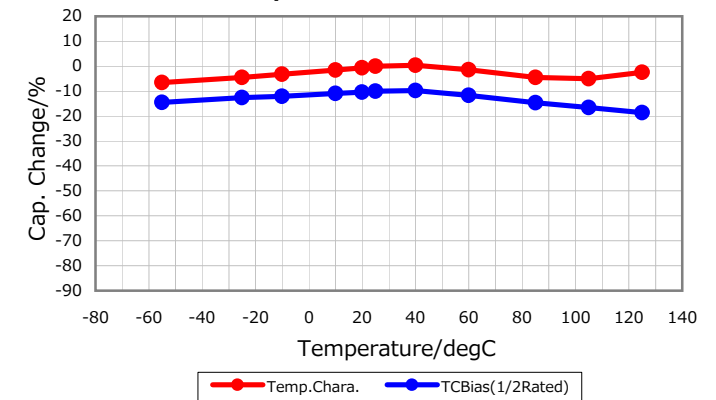
DC Bias Characteristic



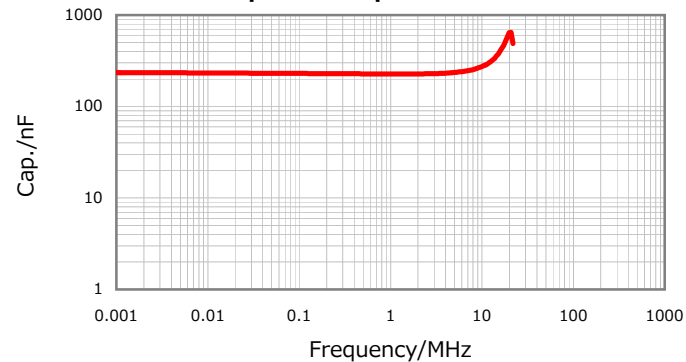
|Z|, ESR vs. Freq. Characteristics



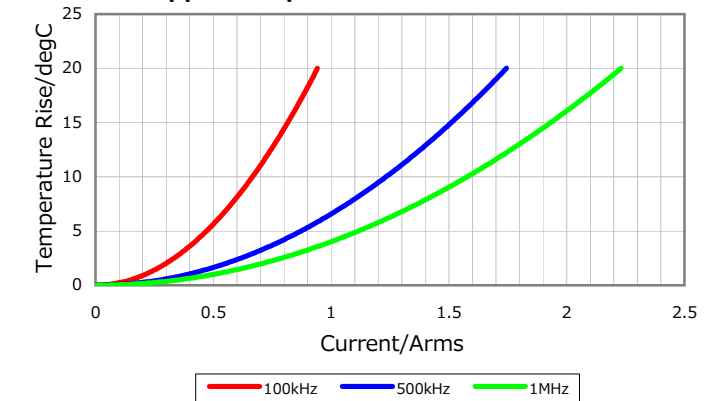
Temperature Characteristics



Cap. vs. Freq. Characteristic



Ripple Temperature Rise Characteristics



Characterization Sheet (Multilayer Ceramic Chip Capacitors)



All specifications are subject to change without notice.

January 3, 2016